



High Performance, Highly Expandable

DS-1300 Expandable Industrial Computer, 10th Gen Intel CPU, Dual PCIe



DS-1302

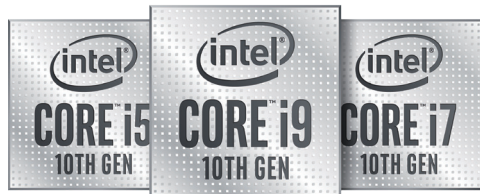
10th Generation Intel Xeon/Core Series Processors, High Performance, Expandable and Modular Rugged Embedded Computer with 2 PCI/PCIe Expansion Slot



- 10-core 10th-gen Intel® Xeon® and Core™ i9/i7/i5/i3 CPU (max 95 W TDP)
- 2x GbE LAN and optional 2x 10GbE LAN
- 2x 2.5" SATA storage, 3x mSATA sockets, 1x M.2 key M for NVMe SSD
- 2x PCI/PCIe expansion slots
- 3x full-size Mini PCIe sockets, 2x SIM card slots
- Optional CMI modules for I/O expansion
- Optional CFM modules for ignition sensing & PoE
- Wide operating temperature -40°C to 70°C
- MIL-STD-810G military standard (pending) and EN50155 (EN 50121-3-2 only)



The DS-1302 is powered by a workstation-grade 10th-gen Intel® Xeon® or Core™ processor, combining high-performance computing with an industrial-grade design and versatile functions. With rich industrial I/O and dual PCI/PCIe expansion capability, the DS-1302 is a robust and expandable platform for different applications in today's industrial automation.



10-CORE & 95W

Workstation Grade Processor Support!

10-Core, Up To 95 W CPU

The DS-1300 series, powered by a workstation-grade 10th-gen Intel® Xeon® or Core™ i9/i7/i5/i3 CPU with up to 10-core architecture, provides superior processing performance. The DS-1300 supports Xeon® CPU up to 95 W TDP. It incorporates DDR4 2933/2666 MHz memory up to 64 GB, delivering unparalleled performance in a rugged, fanless system.

31% + 10% More Productivity

The DS-1300 series's 10th-gen CPU boasts up to 31% better integer multi-tasking for compute-intensive application performance than 9th-gen CPUs*. DDR4 2933 MHz memory further increases speed by 10%**.

The processing platform delivers the performance required to consolidate multiple workloads for intelligent devices and applications.

* 31% increase for 10th-gen i9-10900E 65W vs 9th-gen i7-9700 65W CPU

** 10% increase for 2933 MHz of DS-1300 vs 2666 MHz of DS-1200.

multi-tasking compute-intensive application

CPU

10th Gen i9-10900

31% ↗

9th Gen i7-9700

Transfer rate

RAM

DDR4 2933 MHz

10% ↗

DDR4 2666 MHz

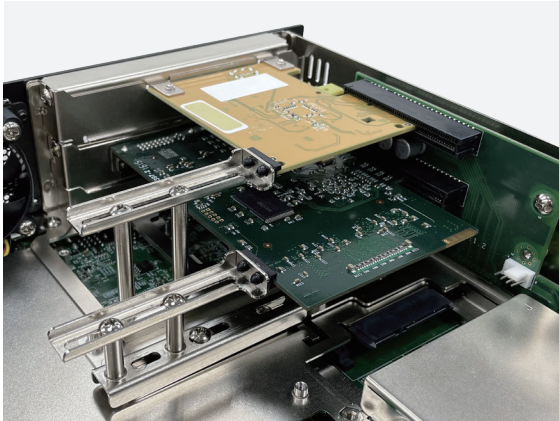


Industrial I/O and Modular Expansion

The DS-1300 series offers a vast array of industrial-focused I/O including up to 2x GbE LAN, 6x USB 3.2, and 2x USB 2.0, 2x RS232/422/485, 2x 2.5" SATA, 3x mSATA, 1x M.2 key M for NVMe SSD, 2x SIM card slots, 3x full-size Mini-PCIe and triple independent displays (DisplayPort, HDMI, VGA). It also features modular expansion through Cincoze's CMI/CFM modules, adding additional I/O or other functionality such as high-speed 10GbE LAN, PoE, and ignition sensing.

PCI/PCIe Add-on Cards

DS-1302 can accommodate dual PCI/PCIe add-on cards up to 111 mm x 235 mm (combined max 110 W). Flexible PCI/PCIe expansion allows the addition of I/O, GPU, image capture, data acquisition, and motion control cards for specific applications.



Adjustable Add-on Card Retainer

The PCI/PCIe expansion slots include two adjustable card retainers that firmly secure the PCI/PCIe add-on cards. The retainer is a cool feature that provides the extra protection needed to prevent add-on cards from shaking loose in high-vibration environments like rolling stock.

PATENT PENDING

Rugged Reliability Against Rigorous Environments

The DS-1300 series's fanless and cableless industrial-grade design can withstand rigorous environments. Its unique thermal design supports an extended operating temperature range from -40°C to 70°C. It has also passed stringent industry standards, including MIL-STD-810G military standard (pending) and EN50155 (EN 50121-3-2 only) for rolling stock environments.



Specifications

System

Processor	Intel® Xeon® Series Processor (95W / 80W / 35W): • Intel® Xeon® W-1290E 10 Cores Up to 4.8 GHz, TDP 95W • Intel® Xeon® W-1270E 8 Cores Up to 4.8 GHz, TDP 80W • Intel® Xeon® W-1250E 6 Cores Up to 4.7 GHz, TDP 80W • Intel® Xeon® W-1290TE 10 Cores Up to 4.5 GHz, TDP 35W • Intel® Xeon® W-1270TE 8 Cores Up to 4.4 GHz, TDP 35W • Intel® Xeon® W-1250TE 6 Cores Up to 3.8 GHz, TDP 35W Intel® Core® Series Processor (65W / 35W): • Intel® Core™ i9-10900E 10 Cores Up to 4.7 GHz, TDP 65W • Intel® Core™ i7-10700E 8 Cores Up to 4.5 GHz, TDP 65W • Intel® Core™ i5-10500E 6 Cores Up to 4.2 GHz, TDP 65W • Intel® Core™ i3-10100E 4 Cores Up to 3.8 GHz, TDP 65W • Intel® Core™ i9-10900TE 10 Cores Up to 4.5 GHz, TDP 35W • Intel® Core™ i7-10700TE 8 Cores Up to 4.5 GHz, TDP 35W • Intel® Core™ i5-10500TE 6 Cores Up to 3.7 GHz, TDP 35W • Intel® Core™ i3-10100TE 4 Cores Up to 3.6 GHz, TDP 35W Intel® Pentium® Series Processor (58W / 35W): • Intel® Pentium® G6400E 2 Cores Up to 3.8 GHz, TDP 58W • Intel® Pentium® G6400TE 2 Cores Up to 3.2 GHz, TDP 35W Intel® Celeron® Series Processor (58W / 35W): • Intel® Celeron® G5900E 2 Cores Up to 3.2 GHz, TDP 58W • Intel® Celeron® G5900TE 2 Cores Up to 3.0 GHz, TDP 35W
Chipset	• Intel® W480E Chipset
Memory	• 2x DDR4 SO-DIMM Socket, Support Up to 64GB (Un-buffered and non-ECC) • Xeon / i9 / i7 Processor Supports Up to 2933MHz • i5 / i3 Processor Supports Up to 2666 MHz • Pentium / Celeron Processor Supports Up to 2400MHz
BIOS	• AMI BIOS

Graphics

Graphics Engine	• Integrated Intel® UHD-630 Graphics
Maximum Display Output	• Supports Triple Independent Display
HDMI	• 1 x HDMI Connector (4096 x 2160@30Hz)
DP	• 2 x DisplayPort Connector (4096 x 2340@60Hz)
VGA	• 1 x VGA Connector (1920 x 1200 @60Hz)

Audio

Audio Codec	• Realtek® ALC888, High Definition Audio
Line-out	• 1 x Line-out, Phone Jack 3.5mm
Mic-in	• 1 x Mic-in, Phone Jack 3.5mm

I/O

LAN	• 2 x GbE LAN, RJ45 - GbE1: Intel® I219-LM - GbE2: Intel® I210-IT
COM	• 2 x RS-232/422/485 with Auto Flow Control (Supports 5V / 12V), DB9
USB	• 2 x 10Gbps USB 3.2 Gen2, Type A • 4 x 5Gbps USB 3.2 Gen1, Type A • 2 x 480Mbps USB 2.0, Type A
PS/2	• 1 x PS/2, 6 Pin Mini-DIN Female Connector

Specifications

Storage

SSD/HDD	• 1x 2.5" Front Accessible SATA HDD/SSD Bay (SATA 3.0) • 1x 2.5" Internal SATA HDD/SSD Bay (SATA 3.0)
mSATA	• 3x mSATA Socket (SATA 3.0, shared by Mini-PCle socket)
M.2 SSD	• 1x M.2 Key M Type 2280 Socket, Support PCIe x4 NVMe SSD or SATA SSD (SATA 3.0)
RAID	• Support RAID 0/1/5/10

Expansion

PCI Express	• 2 x PCI/PCle Expansion Slot with Optional Riser Card * Supports maximum dimensions of add-on card (H x L): 111.15 x 235 mm
Mini PCI Express	• 3 x Full-size Mini-PCle Socket
SIM Socket	• 2 x SIM Socket
CMI (Combined Multiple I/O) Interface	• 2 x High Speed CMI Interface for optional CMI Module Expansion • 2 x Low Speed CMI Interface for optional CMI Module Expansion
CFM (Control Function Module) Interface	• 1 x CFM IGN Interface for optional CFM-IGN Module Expansion

Other Function

External FAN Connector	• 1 x External FAN Connector, 4-pin Terminal Block (Support Smart Fan by BIOS)
Power Ignition Sensing	• Support Power Ignition Sensing Function with Delay Time Management and Selectable 12V/24V (With Optional CFM Module)
Clear CMOS Switch	• 1 x Clear CMOS Switch
Rest Button	• 1 x Rest Button
Instant Reboot	• Support 0.2sec Instant Reboot Technology
Watchdog Timer	• Software Programmable Supports 256 Levels System Reset

Power

Power Button	• 1 x ATX Power On/Off Button
Power Mode Switch	• 1 x AT/ATX Mode Switch
Power Input	• 9 - 48VDC, 3-pin Terminal Block
Remote Power On/Off	• 1 x Remote Power On/Off, 2-pin Terminal Block
Remote Power LED	• 1 x Remote Power LED, 2-pin Terminal Block
Total Power Budget	• 220W

Physical

Dimension (W x D x H)	• 227 x 261 x 88 mm
Weight Information	• TBC KG
Mechanical Construction	• Extruded Aluminum with Heavy Duty Metal
Mounting	• Wall Mount
Physical Design	• Fanless Design • Cableless Design • Jumper-less Design • Unibody Design

Specifications

Reliability & Protection

Reverse Power Input Protection	• Yes
Over Voltage Protection	• Protection Range: 51~58V • Protection Type: shut down operating voltage, re-power on at the preset level to recover
Over Current Protection	• 15A
Surge Protection	• 3.84 kV (impedance 12 ohm 1.2/50us waveform)
CMOS Battery Backup	• SuperCap Integrated for CMOS Battery Maintenance-free Operation
MTBF	• TBC - Database: Telcordia SR-332 Issue3, Method 1, Case 3

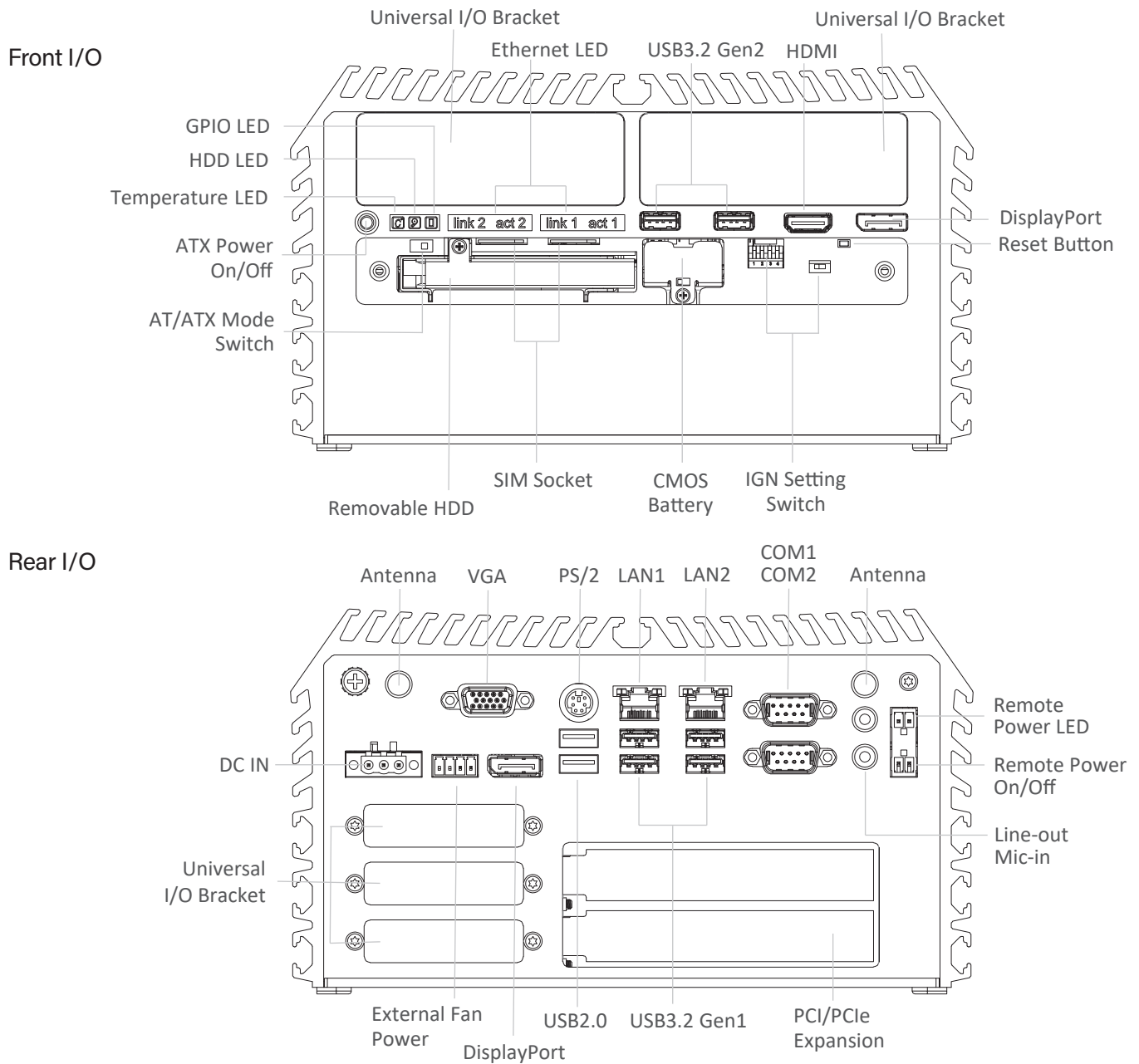
Operating System

Windows	• Windows® 10
Linux	• Supports by project

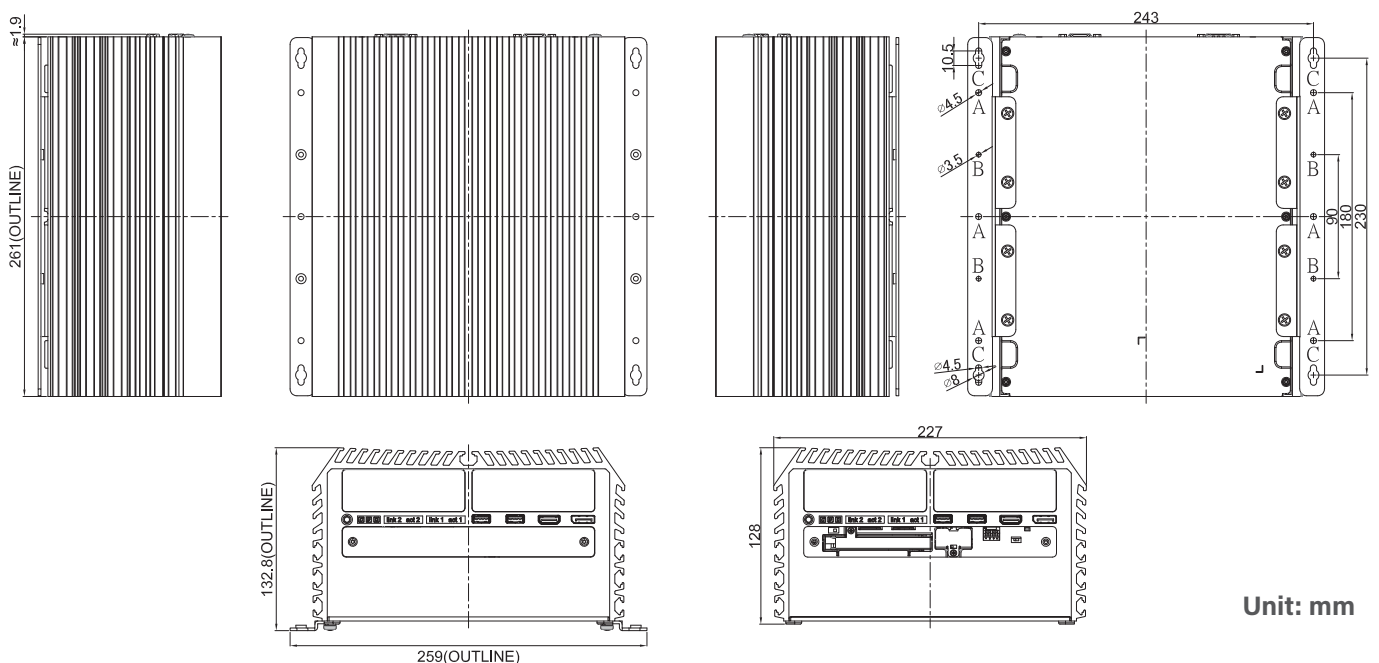
Environment

Operating Temperature	• 35W TDP Processor: -40°C to 70°C • 58W – 65W TDP Processor: TBC • 80W TDP Processor: TBC • 95W TDP Processor: TBC * PassMark BurnInTest: 100% CPU, 2D/3D Graphics (without thermal throttling) * With extended temperature peripherals; Ambient with air flow * According to IEC60068-2-1, IEC60068-2-2, IEC60068-2-14
Storage Temperature	• -40°C to 85°C
Relative Humidity	• 95%RH @ 70°C (non-Condensing)
Shock	• MIL-STD-810G
Vibration	• MIL-STD-810G
EMC	• CE, FCC, ICES-003 Class A, EN50121-3-2 (Railway)
Safety	• IEC/EN 62368-1

External Layout



Dimensions



Ordering Information

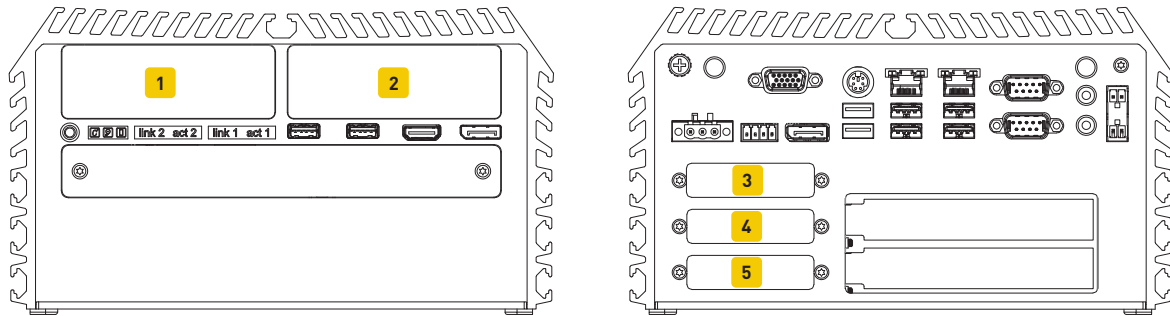
Available Models

Model No.	Description
DS-1302	10th Generation Intel Xeon/Core Series Processors, High Performance, Expandable and Modular Rugged Embedded Computer with 2 PCI/PCIe Expansion Slot

Package Checklist

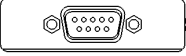
• DS-1302 Embedded System x1	• Heatsink Pack x1
• Utility DVD Driver x1	• Screw Pack x1
• Wall Mount Kit x1	• Power Terminal Block Connector x1
• Remote Function Terminal Block Connector x 2	• Fan Terminal Block Connector x 1

Optional I/O Modules



Model No.	Description	1	2	3	4	5
CMI-LAN01-R12/ UB1012	CMI Module with 4x Intel I210-AT GbE LAN, RJ45 Port / 1x Universal Bracket with 4x RJ45 Cutout for DS Series	V	V	--	--	--
CMI-M12LAN01-R12 /UB1010	CMI Module with M12 Connector, 4x Intel GbE LAN / 1x Universal Bracket with 4x M12 Cutout for DS Series	V	V	--	--	--
CMI-10GLAN03-R10/UB1028	CMI Module with 2x Intel X550 10GbE LAN, RJ45 Port / 1x Universal Bracket with 2x RJ45 Cutout for DS Series	V	--	--	--	--
CMI-COM02/UB1004	CMI Module with 4x RS232/422/485 Ports (Support 5V/12V) / 1x Universal Bracket with 4x DB9 Cutout for DS Series	V	V	--	--	--
CMI-ICOM01/UB1004	CMI Module with 4x Isolated RS232 Ports (Support 5V/12V) / 1x Universal Bracket with 4x DB9 Cutout for DS Series	V	V	--	--	--
CMI-DIO02/UB1018	CMI Module with 16DIO (8in 8out) / 1x Universal Bracket with DIO Cutout for DS Series	V	V	--	--	--

Ordering Information

Model No.	Description	1	2	3	4	5
MEC-COM-M212-DB9 / UB0303 	Mini-PCle Module with 2x RS-232 Ports, 1x Standard DB9 Cable / 2x Universal Bracket each with 1x DB9 Cutout for DS / P1000 Series	--	--	V	V	V
MEC-USB-M102-15 / UB0314 	Mini-PCle Module with 2x USB 3.0 Ports, 1x 15cm cable / 1x Universal Bracket with 2x USB Cutout for DS Series	--	--	V	V	V
MEC-LAN-M002-15 / UB0311 	Mini-PCle Module with 2x LAN Ports, 2x 15cm cable / 1x Universal Bracket with 2x RJ45 Cutout for DS Series	--	--	V	V	V

Remark:

Maximum one CMI-COM02 or CMI-ICOM01 module can be installed in this system.

V : Compatible

Optional Function Modules

Model No.	Description
CFM-PoE03	CFM Module with PoE Function, Individual Port 25.5W for DS-1200/DS-1300 Series
CFM-IGN101	CFM Module with Power Ignition Sensing Function, 12V/24V Selectable for DS Series

Optional Riser Cards

Model No.	Description
RC-E8E8-01	Riser Card with 2 x PCIe8 Slots
RC-E16E1-01	Riser Card with 1x PCIe16 and 1x PCIe1 Slots
RC-E16PI-01	Riser Card with 1x PCIe16 and 1x PCI Slots
RC-PIPI-01	Riser Card with 2x PCI Slots

Optional Accessories

Model No.	Description
FAN-EX101	External Fan with 4pin Terminal Block Plug and Mounting Bracket, Support Smart Fan
GST120A24-CIN	Adapter AC/DC 24V 5A 120W with 3pin Terminal Block Plug and Tubes, Level VI
GST220A24-CIN	Adapter AC/DC 24V 9.2A 220W with 3pin Terminal Block Plug and Tubes, Level VI